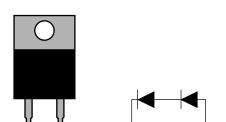
HALOGEN FREE



## Vishay High Power Products

## Hyperfast Rectifier, 8 A FRED Pt®



2L TO-220

| PRODUCT SUMMARY    |       |  |  |  |
|--------------------|-------|--|--|--|
| t <sub>rr</sub>    | 11 ns |  |  |  |
| I <sub>F(AV)</sub> | 8 A   |  |  |  |
| $V_{R}$            | 600 V |  |  |  |

#### **FEATURES**

- Hyperfast recovery time
- · Low forward voltage drop
- · Low leakage current
- 175 °C operating junction temperature
- Compliant to RoHS directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition
- · Designed and qualified for industrial level

#### **DESCRIPTION**

8S2TH06I-M 600 V series are the state of the art tandem hyperfast recovery rectifiers: the new insulated 2 pin TO-220 package provide benchmark thermal resistance that coupled with excellent switching performance and low forward voltage drop allow this device to provide 8 A DC at 120 °C case temperature.

Specially designed for CCM PFC application, these devices show incomparable performance in every current intensive hard switching application.

Optimized reverse recovery stored charge enables downsizing of boosting switch and cooling system. Increased operating frequency make possible use of smaller reactive elements. Cost effective PFC application is then possible with high efficiency over wide input voltage range and loading factor.

The new ceramic insulated package warranty insulation up to 2 kV and features easy mounting together with not insulated parts, with minimum effect on  $R_{th,IC}$ .

| ABSOLUTE MAXIMUM RATINGS FOR BOTH DIODES    |                                   |  |             |       |  |
|---|-----------------------------------|--|-------------|-------|--|
| PARAMETER                                   | RAMETER SYMBOL TEST CONDITIONS    |  | MAX.        | UNITS |  |
| Repetitive peak reverse voltage             | $V_{RRM}$                         |  | 600         | V     |  |
| DC forward current                          | I <sub>F</sub>                    | 50 % duty cycle, rect. waveforms, $T_C = 120$ °C | 8           | Δ     |  |
| Non-repetitive peak surge current           | I <sub>FSM</sub>                  | T <sub>C</sub> = 25 °C                           | 140         | - A   |  |
| Operating junction and storage temperatures | T <sub>J</sub> , T <sub>Stg</sub> |  | - 55 to 175 | °C    |  |

| <b>ELECTRICAL SPECIFICATIONS FOR BOTH DIODES</b> (T <sub>J</sub> = 25 °C unless otherwise specified) |                                     |  |      |      |      |       |
|--|-------------------------------------|--|------|------|------|-------|
| PARAMETER  | SYMBOL                              | TEST CONDITIONS  | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage,<br>blocking voltage   | V <sub>BR</sub> ,<br>V <sub>R</sub> | Ι <sub>R</sub> = 100 μΑ  | 600  | -    | -    |       |
| Forward voltage V <sub>F</sub>   |                                     | I <sub>F</sub> = 8 A   | -    | 2.7  | 3.1  | V     |
|  | V <sub>F</sub>                      | I <sub>F</sub> = 8 A, T <sub>J</sub> = 125 °C                  | -    | 2.1  | 2.3  |       |
|  |                                     | I <sub>F</sub> = 8 A, T <sub>J</sub> = 150 °C                  | -    | 1.9  | 2.1  |       |
|  |                                     | $V_R = V_R$ rated  | -    | < 1  | 10   |       |
| Reverse leakage current  | I <sub>R</sub>                      | $T_J = 125$ °C, $V_R = V_R$ rated                              | -    | 7    | 50   | μΑ    |
|  |                                     | T <sub>J</sub> = 150 °C, V <sub>R</sub> = V <sub>R</sub> rated | -    | 27   | 80   |       |
| Junction capacitance   | C <sub>T</sub>                      | V <sub>R</sub> = 600 V   | -    | 10.5 | -    | pF    |

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## 8S2TH06I-M

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| <b>DYNAMIC RECOVERY CHARACTERISTICS FOR BOTH DIODES</b> (T <sub>J</sub> = 25 °C unless otherwise specified) |                                      |  |  |      |      |      |       |
|---|--------------------------------------|--|--|------|------|------|-------|
| PARAMETER   | SYMBOL                               | TEST CONDITIONS  |  | MIN. | TYP. | MAX. | UNITS |
|   |                                      | $I_F = 1.0 \text{ A}, dI_F/dt = -50 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$ |  | -    | 13   | 20   |       |
| Reverse recovery time   | everse recovery time t <sub>rr</sub> | T <sub>J</sub> = 25 °C   |  | -    | 11   | 16   | ns    |
|   |                                      | T <sub>J</sub> = 125 °C  | $I_F = 8 \text{ A}$<br>$dI_F/dt = -200 \text{ A/}\mu\text{s}$<br>$V_R = 390 \text{ V}$ | -    | 23   | 30   |       |
| Peak recovery current I <sub>RRM</sub>  |                                      | T <sub>J</sub> = 25 °C   |  | -    | 1.5  | 2.5  | А     |
|   | 'RRM                                 | T <sub>J</sub> = 125 °C  |  | -    | 2.8  | 3.7  | A     |
| Reverse recovery charge Q <sub>rr</sub>   | Q <sub>rr</sub>                      | T <sub>J</sub> = 25 °C   |  | -    | 7    | 15   | nC    |
|   |                                      | T <sub>J</sub> = 125 °C  |  | -    | 35   | 51   | IIC   |

| THERMAL - MECHANICAL SPECIFICATIONS FOR BOTH DIODES |                                   |  |              |                  |            |                        |
|---|-----------------------------------|--|--------------|------------------|------------|------------------------|
| PARAMETER   | SYMBOL                            | TEST CONDITIONS                            | MIN.         | TYP.             | MAX.       | UNITS                  |
| Maximum junction and storage temperature range      | T <sub>J</sub> , T <sub>Stg</sub> |  | - 55         | -                | 175        | °C                     |
| Thermal resistance, junction to case                | R <sub>thJC</sub>                 |  | -            | 2.30             | 2.85       | °C/W                   |
| Thermal resistance, case to heatsink                | R <sub>thCS</sub>                 | Mounting surface, flat, smooth and greased | -            | 0.1              | -          | - 'C/VV                |
| Approximate weight                                  |                                   |  | -            | 2.0              | -          | g                      |
| Approximate weight                                  |                                   |  | -            | 0.07             | -          | OZ.                    |
| Mounting torque                                     |                                   |  | 6.0<br>(5.0) | -                | 12<br>(10) | kgf · cm<br>(lbf · in) |
| Marking device                                      |                                   | Case style 2L TO-220                       |              | 8S2 <sup>-</sup> | TH06I      |                        |

Document Number: 93049 Revision: 26-Aug-09





### Hyperfast Rectifier, 8 A FRED Pt<sup>®</sup>

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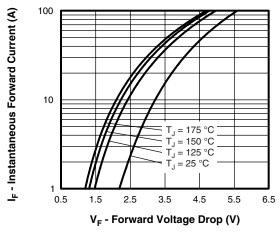


Fig. 1 - Typical Forward Voltage Drop Characteristics

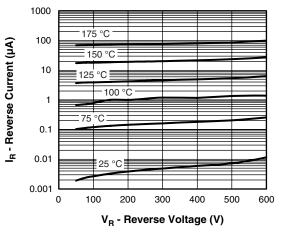


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

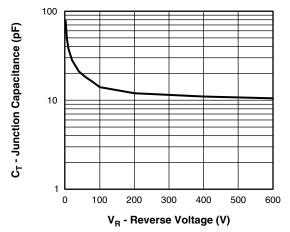


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

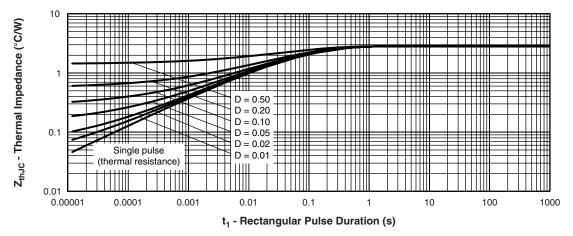


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

### 8S2TH06I-M

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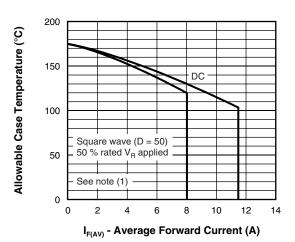


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

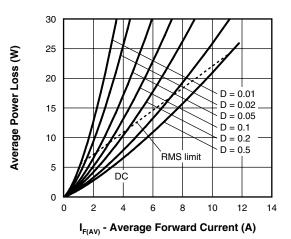


Fig. 6 - Forward Power Loss Characteristics

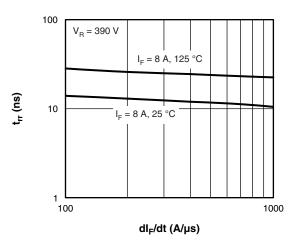


Fig. 7 - Typical Reverse Recovery Time vs.  $dI_F/dt$ 

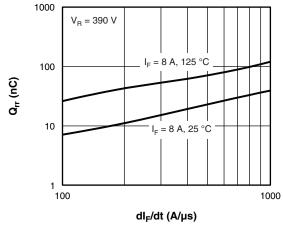


Fig. 8 - Typical Stored Charge vs. dI<sub>F</sub>/dt

#### Note

 $\begin{array}{l} \text{(1) Formula used: } T_{C} = T_{J} \text{ - (Pd +Pd}_{REV}) \text{ x } R_{thJC}; \\ Pd = Forward power loss = I_{F(AV)} \text{ x } V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = Inverse power loss = V_{R1} \text{ x } I_{R} \text{ (1 - D); } I_{R} \text{ at } V_{R1} = 50 \text{ \% rated } V_{R} \\ \end{array}$ 

| LINKS TO RELATED DOCUMENTS                 |                          |  |  |  |  |
|--|--------------------------|--|--|--|--|
| Dimensions <u>www.vishay.com/doc?95171</u> |                          |  |  |  |  |
| Part marking information                   | www.vishay.com/doc?95170 |  |  |  |  |



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